## Infonote

AO-IN-2024-004-I

New lead frame for SOIC8 package family





15.01.2024

Dear Customer,

Please take note of this Infonote.

This customer notification is for information only and does not require customer approval.

Objective:	New lead frame for SOIC8 package family	
Affected products:	186210071 AS5162-HSOP SOIC8 LF T&RDP Q65114A0708 186210079 AS5161-HSOP SOIC8 LF T&RDP Q65114A0709 186210086 AS5162-HSOM SOIC8 LF T&RDP Q65114A0710 186210089 AS5161-HSOM SOIC8 LF T&RDP Q65114A0711	
Reason for change:	Conversion of existing customized lead frame to new standardized lead frame.	
	Current status	New status
Description of change:	Leadframe SOIC 8L XDLF (large matrix Leadframe)	Leadframe SOIC 8L XDLF (large matrix Leadframe) with slightly larger pad size
Time schedule:	Start of production: September 2024	
Assessment:	Change is low risk. Nevertheless, qualification will be performed to be compliant with Standards.	